



# Fiducial Mark Interoperability TF Report

As of December 16, 2015

## TF Leadership (No Change)

- H. Tsunobuchi / KEYENCE  
Traceability Committee
- T. Nakai / SUMCO  
Silicon Wafer Committee
- S. Mashiro / Tokyo Electron  
Physical Interface and Carrier Committee
- S. Masuchi / DISCO  
Assembly and Package Committee
- M. Matsuda / Hitachi Kokusai  
Information and Control Committee

# Recent TF activity

- TF meeting on April 27, 2015 and June 11, 2015
- T7 issues
  - TF decided to delete all position specifications from SEMI T7 because position specifications are also described on SEMI M1 and other related Silicon Standard.
  - Document 5890 was submitting to Cycle 7
    - No reject. Three Comments with Accept
  - Discussed Comment on 18 Nov. → Editorial Change and forward to JA Maintenance TF for further consideration.
  - To be adjudicated at the next JA TC Chapter meeting of Traceability TC in conjunction with SEMICON JAPAN 2015 on Dec. 18.
- Others
  - Assembly and Packaging: Discussing backend alignment issues with introducing fiducial mark wafer.
  - TF leaders to start discussion about disbanding this TF if the TF doesn't have further activity.

# Next Meeting

- TBD